IN THE UNITED STATES PATENT AND TRADEMARK OFFICE In re U.S. Patent Application of SHIMANUKI et al. Application Number: 10/091,302 Filed: March 6, 2002 For: A MANUFACTURING METHOD OF A SEMICONDUCTOR DEVICE

Honorable Assistant Commissioner for Patents Washington, D.C. 20231

ATTORNEY DOCKET NO. HITA.0176

COVER LETTER

Sir:

[] The fee for submission of additional claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL Currently On File	CLAIMS PAID	RATE	CALCULATION	
Total Claims	4	80	60 (Over 20)	x \$18		
Independent Claims	1	4	(Over 3)	x \$84	. ,	
MULTIPLE DEPENDENT CLAIM(S)				+ \$280	. 0	
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED						
			ТОТА	L :	138.00	

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

[x] Response to Office Action	[] Petition for Extension of Time
(with Claim Amendments)	[] Terminal Disclaimer
[] Substitute Specification	[] Letter to Draftsperson
[] Preliminary Amendment	[] Assignment
[] Other	Petition under

[]	Please charge my Deposit Account Number for . A duplicate copy of				
	. A duplicate copy C	it this paper is enclosed.			
[]	A check in the amount of \$0.00 to cover the ex	cess claims fee is enclosed.			
[x]	The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to Deposit Account Number 08-1480 .				
		Respectfully submitted Stanley P. Pisher Registration Number 24,344			
		Juan Carlos A. Marquez Registration Number 34,072			

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July 24, 2003